

## 16-Bit Registered Transceivers

### Features

- $I_{off}$  supports partial-power-down mode operation
- Edge-rate control circuitry for significantly improved noise characteristics
- Typical output skew < 250 ps
- ESD > 2000V
- TSSOP (19.6-mil pitch) and SSOP (25-mil pitch) packages
- Industrial temperature range of  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$
- $V_{CC} = 5\text{V} \pm 10\%$

#### CY74FCT16652T Features:

- 64 mA sink current, 32 mA source current
- Typical  $V_{OLP}$  (ground bounce) < 1.0V at  $V_{CC} = 5\text{V}$ ,  $T_A = 25^{\circ}\text{C}$

#### CY74FCT162652T Features:

- Balanced 24 mA output drivers
- Reduced system switching noise
- Typical  $V_{OLP}$  (ground bounce) < 0.6V at  $V_{CC} = 5\text{V}$ ,  $T_A = 25^{\circ}\text{C}$

### Functional Description

These 16-bit, high-speed, low-power, registered transceivers that are organized as two independent 8-bit bus transceivers with three-state D-type registers and control circuitry arranged for multiplexed transmission of data directly from the input bus or from the internal storage registers. OEAB and OEBA control pins are provided to control the transceiver functions. SAB and SBA control pins are provided to select either real-time or stored data transfer.

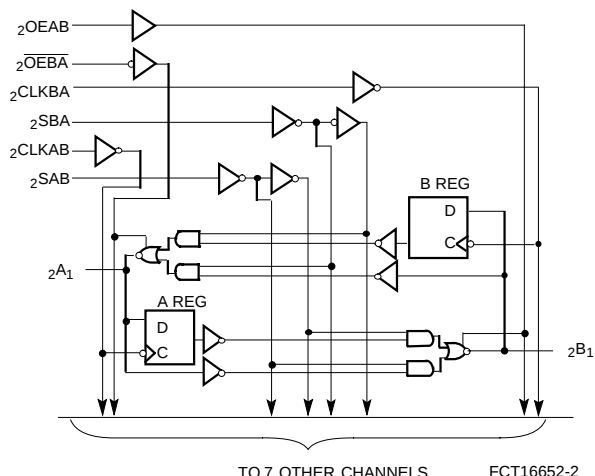
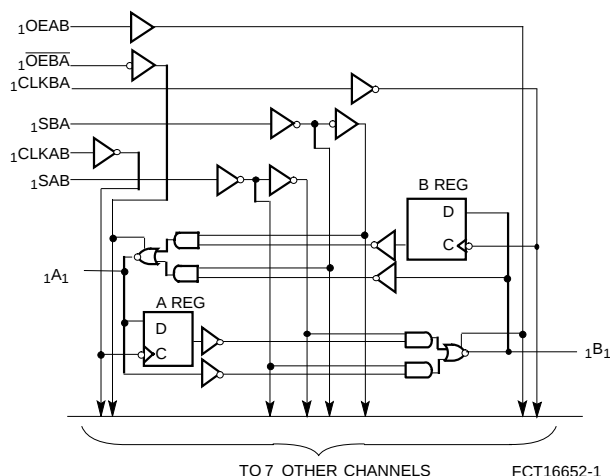
Data on the A or B data bus, or both, can be stored in the internal D flip-flops by LOW-to-HIGH transitions at the appropriate clock pins (CLKAB or CLKBA), regardless of the select or enable control pins. When SAB and SBA are in the real-time transfer mode, it is also possible to store data without using the internal D-type flip-flops by simultaneously enabling OEAB and OEBA. In this configuration, each output reinforces its input. Thus, when all other data sources to the two sets of bus lines are at high impedance, each set of bus lines will remain at its last state.

This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The CY74FCT16652T is ideally suited for driving high-capacitance loads and low-impedance backplanes.

The CY74FCT162652T has 24-mA balanced output drivers with current-limiting resistors in the outputs. This reduces the need for external terminating resistors and provides for minimal undershoot and reduced ground bounce. The CY74FCT162652T is ideal for driving transmission lines.

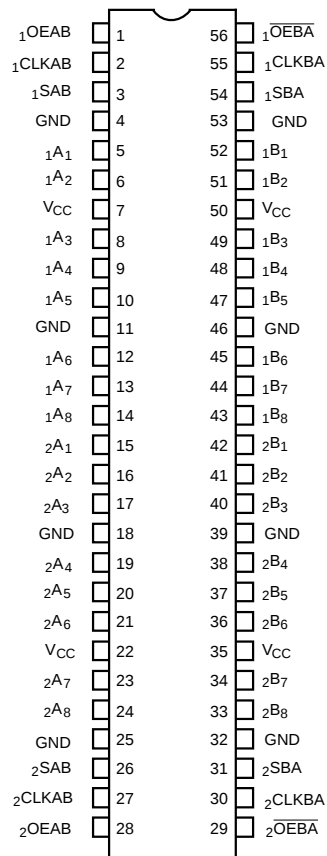
### Logic Block Diagrams



### Pin Configuration

#### SSOP/TSSOP

#### Top View



FCT16652-3

### Pin Description

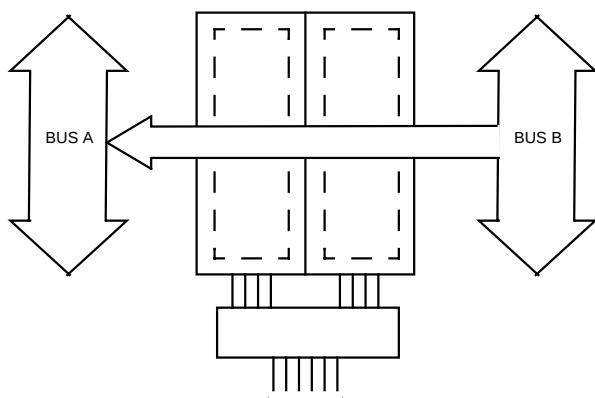
| Name         | Description                                       |
|--------------|---------------------------------------------------|
| A            | Data Register A Inputs<br>Data Register B Outputs |
| B            | Data Register B Inputs<br>Data Register A Outputs |
| CLKAB, CLKBA | Clock Pulse Inputs                                |
| SAB, SBA     | Output Data Source Select Inputs                  |
| OEAB, OEBA   | Output Enable Inputs                              |

**Function Table<sup>[1]</sup>**

| Inputs |        |             |             |                       |                       | Data I/O <sup>[2]</sup>    |                                      | Operation or Function                                |
|--------|--------|-------------|-------------|-----------------------|-----------------------|----------------------------|--------------------------------------|------------------------------------------------------|
| OEAB   | OEBA   | CLKAB       | CLKBA       | SAB                   | SBA                   | A                          | B                                    |                                                      |
| L<br>L | H<br>H | H or L<br>┐ | H or L<br>┐ | X<br>X                | X<br>X                | Input                      | Input                                | Isolation<br>Store A and B Data                      |
| X<br>H | H<br>H | ┐<br>┐      | H or L<br>┐ | X<br>X <sup>[3]</sup> | X<br>X                | Input<br>Input             | Unspecified <sup>[2]</sup><br>Output | Store A, Hold B<br>Store A in Both Registers         |
| L<br>L | X<br>L | H or L<br>┐ | ┐<br>┐      | X<br>X                | X<br>X <sup>[3]</sup> | Unspecified <sup>[2]</sup> | Input<br>Input                       | Hold A, Store B<br>Store B in both Registers         |
| L<br>L | L<br>L | X<br>X      | X<br>H or L | X<br>X                | L<br>H                | Output                     | Input                                | Real Time B Data to A Bus<br>Stored B Data to A Bus  |
| H<br>H | H<br>H | X<br>H or L | X<br>X      | L<br>H                | X<br>X                | Input                      | Output                               | Real Time A Data to B Bus<br>Stored A Data to B Bus  |
| H      | L      | H or L      | H or L      | H                     | H                     | Output                     | Output                               | Stored A Data to B Bus and<br>Stored B Data to A Bus |

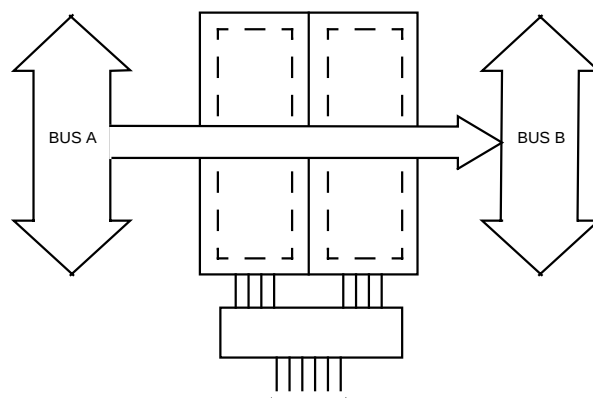
**Notes:**

1. H = HIGH Voltage Level  
L = LOW Voltage Level  
X = Don't Care  
┐ = LOW-to-HIGH Transition
2. The data output functions may be enabled or disabled by various signals at the OEAB or OEBA inputs. Data input functions are always enabled, i.e., data at the bus pins will be stored on every LOW-to-HIGH transition on the clock inputs.
3. Select control=L; clocks can occur simultaneously.  
Select control=H; clocks must be staggered to load both registers.



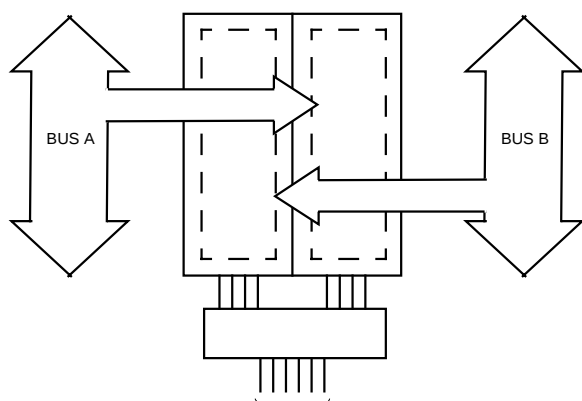
OEAB L    OEBA L    CLKAB X    CLKBA X    SAB X    SBA L

**Real-Time Transfer  
Bus B to Bus A**



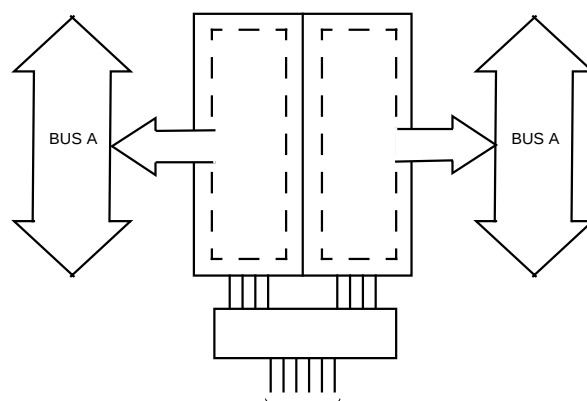
OEAB H    OEBA L    CLKAB X    CLKBA X    SAB L    SBA X

**Real-Time Transfer  
Bus A to Bus B**



OEAB X L L    OEBA H X H    CLKAB X X X    CLKBA X X X    SAB X X X    SBA X X X

**Storage from  
A and/or B**



OEAB H    OEBA L    CLKAB H or L    CLKBA H or L    SAB H    SBA H

**Transfer Stored Data  
to A and/or B**

## Maximum Ratings<sup>[4]</sup>

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature .....Com'l -55°C to +125°C

Ambient Temperature with  
Power Applied .....Com'l -55°C to +125°C

DC Input Voltage .....-0.5V to +7.0V

DC Output Voltage .....-0.5V to +7.0V

DC Output Current  
(Maximum Sink Current/Pin) .....-60 to +120 mA

Power Dissipation .....1.0W

Static Discharge Voltage.....>2001V  
(per MIL-STD-883, Method 3015)

## Operating Range

| Range      | Ambient Temperature | V <sub>CC</sub> |
|------------|---------------------|-----------------|
| Industrial | -40°C to +85°C      | 5V ± 10%        |

### Note:

- Stresses greater than those listed under Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

**DC Electrical Characteristics** Over the Operating Range

| Parameter        | Description                                                | Test Conditions <sup>[5]</sup>                             | Min. | Typ. <sup>[6]</sup> | Max. | Unit |
|------------------|------------------------------------------------------------|------------------------------------------------------------|------|---------------------|------|------|
| V <sub>IH</sub>  | Input HIGH Voltage                                         | Logic HIGH Level                                           | 2.0  |                     |      | V    |
| V <sub>IL</sub>  | Input LOW Voltage                                          | Logic LOW Level                                            |      |                     | 0.8  | V    |
| V <sub>H</sub>   | Input Hysteresis                                           |                                                            |      | 100                 |      | mV   |
| V <sub>IK</sub>  | Input Clamp Diode Voltage                                  | V <sub>CC</sub> =Min., I <sub>IN</sub> =−18 mA             |      | −0.7                | −1.2 | V    |
| I <sub>IH</sub>  | Input HIGH Current                                         | V <sub>CC</sub> =Max., V <sub>I</sub> =V <sub>CC</sub>     |      |                     | ±1   | μA   |
| I <sub>IL</sub>  | Input LOW Current                                          | V <sub>CC</sub> =Max., V <sub>I</sub> =GND                 |      |                     | ±1   | μA   |
| I <sub>OZH</sub> | High Impedance Output Current<br>(Three-State Output pins) | V <sub>CC</sub> =Max., V <sub>OUT</sub> =2.7V              |      |                     | ±1   | μA   |
| I <sub>OZL</sub> | High Impedance Output Current<br>(Three-State Output pins) | V <sub>CC</sub> =Max., V <sub>OUT</sub> =0.5V              |      |                     | ±1   | μA   |
| I <sub>OS</sub>  | Short Circuit Current <sup>[8]</sup>                       | V <sub>CC</sub> =Max., V <sub>OUT</sub> =GND               | −80  | −140                | −200 | mA   |
| I <sub>O</sub>   | Output Drive Current <sup>[8]</sup>                        | V <sub>CC</sub> =Max., V <sub>OUT</sub> =2.5V              | −50  |                     | −180 | mA   |
| I <sub>OFF</sub> | Power-Off Disable                                          | V <sub>CC</sub> =0V, V <sub>OUT</sub> ≤4.5V <sup>[7]</sup> |      |                     | ±1   | μA   |

**Output Drive Characteristics for CY74FCT16652T**

| Parameter       | Description         | Test Conditions <sup>[5]</sup>                 | Min. | Typ. <sup>[6]</sup> | Max. | Unit |
|-----------------|---------------------|------------------------------------------------|------|---------------------|------|------|
| V <sub>OH</sub> | Output HIGH Voltage | V <sub>CC</sub> =Min., I <sub>OH</sub> =−3 mA  | 2.5  | 3.5                 |      | V    |
|                 |                     | V <sub>CC</sub> =Min., I <sub>OH</sub> =−15 mA | 2.4  | 3.5                 |      |      |
|                 |                     | V <sub>CC</sub> =Min., I <sub>OH</sub> =−32 mA | 2.0  | 3.0                 |      |      |
| V <sub>OL</sub> | Output LOW Voltage  | V <sub>CC</sub> =Min., I <sub>OL</sub> =64 mA  |      | 0.2                 | 0.55 | V    |

**Output Drive Characteristics for CY74FCT162652T**

| Parameter        | Description                        | Test Conditions <sup>[5]</sup>                                                                    | Min. | Typ. <sup>[6]</sup> | Max. | Unit |
|------------------|------------------------------------|---------------------------------------------------------------------------------------------------|------|---------------------|------|------|
| I <sub>ODL</sub> | Output LOW Current <sup>[8]</sup>  | V <sub>CC</sub> =5V, V <sub>IN</sub> =V <sub>IH</sub> or V <sub>IL</sub> , V <sub>OUT</sub> =1.5V | 60   | 115                 | 150  | mA   |
| I <sub>ODH</sub> | Output HIGH Current <sup>[8]</sup> | V <sub>CC</sub> =5V, V <sub>IN</sub> =V <sub>IH</sub> or V <sub>IL</sub> , V <sub>OUT</sub> =1.5V | −60  | −115                | −150 | mA   |
| V <sub>OH</sub>  | Output HIGH Voltage                | V <sub>CC</sub> =Min., I <sub>OH</sub> =−24 mA                                                    | 2.4  | 3.3                 |      | V    |
| V <sub>OL</sub>  | Output LOW Voltage                 | V <sub>CC</sub> =Min., I <sub>OL</sub> =24 mA                                                     |      | 0.3                 | 0.55 | V    |

**Capacitance** (T<sub>A</sub> = +25°C, f = 1.0 MHz)

| Parameter        | Description <sup>[10]</sup> | Test Conditions       | Typ. | Max. | Unit |
|------------------|-----------------------------|-----------------------|------|------|------|
| C <sub>IN</sub>  | Input Capacitance           | V <sub>IN</sub> = 0V  | 4.5  | 6.0  | pF   |
| C <sub>OUT</sub> | Output Capacitance          | V <sub>OUT</sub> = 0V | 5.5  | 8.0  | pF   |

**Notes:**

5. For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.
6. Typical values are at V<sub>CC</sub>=5.0V, +25°C ambient.
7. Tested at T<sub>A</sub>= +25°C.
8. Not more than one output should be tested at one time. Duration of the test should not exceed one second.
9. Duration of the condition cannot exceed one second.
10. This parameter is measured at characterization but not tested.

**Power Supply Characteristics**

| Param.          | Description                                       | Test Conditions <sup>[11]</sup>                                                                                                                                                                    |                                                   | Min. | Typ. <sup>[12]</sup> | Max.                 | Unit          |
|-----------------|---------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------|------|----------------------|----------------------|---------------|
| $I_{CC}$        | Quiescent Power Supply Current                    | $V_{CC} = \text{Max.}$                                                                                                                                                                             | $V_{IN} \leq 0.2V$<br>$V_{IN} \geq V_{CC} - 0.2V$ | —    | 5                    | 500                  | $\mu A$       |
| $\Delta I_{CC}$ | Quiescent Power Supply Current<br>TTL Inputs HIGH | $V_{CC} = \text{Max.}$ $V_{IN} = 3.4V$ <sup>[13]</sup>                                                                                                                                             |                                                   | —    | 0.5                  | 1.5                  | mA            |
| $I_{CCD}$       | Dynamic Power Supply Current <sup>[14]</sup>      | $V_{CC} = \text{Max.}$<br>Outputs Open<br>$OEAB = \overline{OEAB} = GND$<br>One Input Toggling<br>50% Duty Cycle                                                                                   | $V_{IN} = V_{CC}$ or<br>$V_{IN} = GND$            | —    | 75                   | 120                  | $\mu A / MHz$ |
| $I_C$           | Total Power Supply Current <sup>[15]</sup>        | $V_{CC} = \text{Max.}$<br>Outputs Open<br>$f_0 = 10 \text{ MHz (CLKBA)}$<br>50% Duty Cycle<br>$OEAB = \overline{OEAB} = GND$<br>One-Bit Toggling<br>$f_1 = 5 \text{ MHz}$<br>50% Duty Cycle        | $V_{IN} = V_{CC}$ or<br>$V_{IN} = GND$            | —    | 0.8                  | 1.7                  | mA            |
|                 |                                                   |                                                                                                                                                                                                    | $V_{IN} = 3.4V$ or<br>$V_{IN} = GND$              | —    | 1.3                  | 3.2                  | mA            |
|                 |                                                   | $V_{CC} = \text{Max.}$<br>Outputs Open<br>$f_0 = 10 \text{ MHz (CLKBA)}$<br>50% Duty Cycle<br>$OEAB = \overline{OEAB} = GND$<br>Sixteen Bits Toggling<br>$f_1 = 2.5 \text{ MHz}$<br>50% Duty Cycle | $V_{IN} = V_{CC}$ or<br>$V_{IN} = GND$            | —    | 3.8                  | 6.5 <sup>[16]</sup>  | mA            |
|                 |                                                   |                                                                                                                                                                                                    | $V_{IN} = 3.4V$ or<br>$V_{IN} = GND$              | —    | 8.3                  | 20.0 <sup>[16]</sup> | mA            |

**Notes:**

11. For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.
12. Typical values are at  $V_{CC} = 5.0V$  +25° ambient.
13. Per TTL driven input ( $V_{IN} = 3.4V$ ); all other inputs at  $V_{CC}$  or GND.
14. This parameter is not directly testable, but is derived for use in Total Power Supply calculations.
15.  $I_C = I_{QUIESCENT} + I_{INPUTS} + I_{DYNAMIC}$   
 $I_C = I_{CC} + \Delta I_{CC} D_H N_T + I_{CCD} (f_0/2 + f_1 N_1)$   
 $I_{CC}$  = Quiescent Current with CMOS input levels  
 $\Delta I_{CC}$  = Power Supply Current for a TTL HIGH input ( $V_{IN} = 3.4V$ )  
 $D_H$  = Duty Cycle for TTL inputs HIGH  
 $N_T$  = Number of TTL inputs at  $D_H$   
 $I_{CCD}$  = Dynamic Current caused by an input transition pair (HLH or LHL)  
 $f_0$  = Clock frequency for registered devices, otherwise zero  
 $f_1$  = Input signal frequency  
 $N_1$  = Number of inputs changing at  $f_1$   
 All currents are in milliamps and all frequencies are in megahertz.
16. Values for these conditions are examples of the  $I_{CC}$  formula. These limits are specified but not tested.

**Switching Characteristics** Over the Operating Range<sup>[17]</sup>

| Parameter                            | Description                                                 | CY74FCT16652AT<br>CY74FCT162652AT |      | Unit | Fig. No. <sup>[18]</sup> |
|--------------------------------------|-------------------------------------------------------------|-----------------------------------|------|------|--------------------------|
|                                      |                                                             | Min.                              | Max. |      |                          |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay Bus to Bus                                | 1.5                               | 6.3  | ns   | 1, 3                     |
| t <sub>PZH</sub><br>t <sub>PHL</sub> | Output Enable Time OEAB or $\overline{\text{OEBA}}$ to Bus  | 1.5                               | 9.8  | ns   | 1, 7, 8                  |
| t <sub>PHZ</sub><br>t <sub>PLZ</sub> | Output Disable Time OEAB or $\overline{\text{OEBA}}$ to Bus | 1.5                               | 6.3  | ns   | 1, 7, 8                  |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay Clock to Bus                              | 1.5                               | 6.3  | ns   | 1, 5                     |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay SBA or SAB to Bus                         | 1.5                               | 7.7  | ns   | 1, 5                     |
| t <sub>SU</sub>                      | Set-Up time HIGH or LOW Bus to Clock                        | 2.0                               | —    | ns   | 4                        |
| t <sub>H</sub>                       | Hold Time HIGH or LOW Bus to Clock                          | 1.5                               | —    | ns   | 4                        |
| t <sub>W</sub>                       | Clock Pulse Width HIGH or LOW                               | 5.0                               | —    | ns   | 5                        |
| t <sub>SK(O)</sub>                   | Output Skew <sup>[19]</sup>                                 | —                                 | 0.5  | ns   |                          |

| Parameter                            | Description                                                    | CY74FCT16652CT<br>CY74FCT162652CT |      | Unit | Fig. No. <sup>[18]</sup> |
|--------------------------------------|----------------------------------------------------------------|-----------------------------------|------|------|--------------------------|
|                                      |                                                                | Min.                              | Max. |      |                          |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>Bus to Bus                                | 1.5                               | 5.4  | ns   | 1, 3                     |
| t <sub>PZH</sub><br>t <sub>PHL</sub> | Output Enable Time<br>OEAB or $\overline{\text{OEBA}}$ to Bus  | 1.5                               | 7.8  | ns   | 1, 7, 8                  |
| t <sub>PHZ</sub><br>t <sub>PLZ</sub> | Output Disable Time<br>OEAB or $\overline{\text{OEBA}}$ to Bus | 1.5                               | 6.3  | ns   | 1, 7, 8                  |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>Clock to Bus                              | 1.5                               | 5.7  | ns   | 1, 5                     |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>SBA or SAB to Bus                         | 1.5                               | 6.2  | ns   | 1, 5                     |
| t <sub>SU</sub>                      | Set-Up Time<br>HIGH or LOW<br>Bus to Clock                     | 2.0                               | —    | ns   | 4                        |
| t <sub>H</sub>                       | Hold Time<br>HIGH or LOW<br>Bus to Clock                       | 1.5                               | —    | ns   | 4                        |
| t <sub>W</sub>                       | Clock Pulse Width<br>HIGH or LOW                               | 5.0                               | —    | ns   | 5                        |
| t <sub>SK(O)</sub>                   | Output Skew <sup>[19]</sup>                                    | —                                 | 0.5  | ns   |                          |

**Notes:**

17. Minimum limits are specified, but not tested, on propagation delays.

18. See "Parameter Measurement Information" in the General Information section.

19. Skew between any two outputs of the same package switching in the same direction. This parameter ensured by design.

**Ordering Information CY74FCT16652**

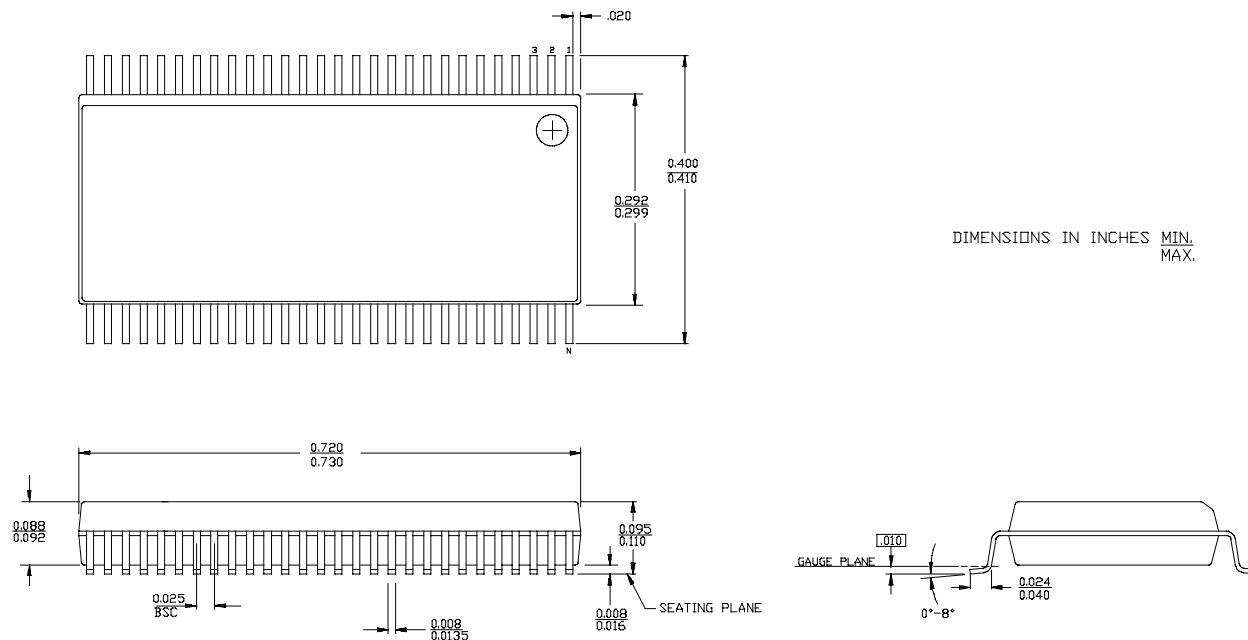
| Speed (ns) | Ordering Code          | Package Name | Package Type           | Operating Range |
|------------|------------------------|--------------|------------------------|-----------------|
| 5.4        | CY74FCT16652CTPVC/PVCT | O56          | 56-Lead (300-Mil) SSOP | Industrial      |
| 6.3        | CY74FCT16652ATPVC/PVCT | O56          | 56-Lead (300-Mil) SSOP | Industrial      |

**Ordering Information CY74FCT162652**

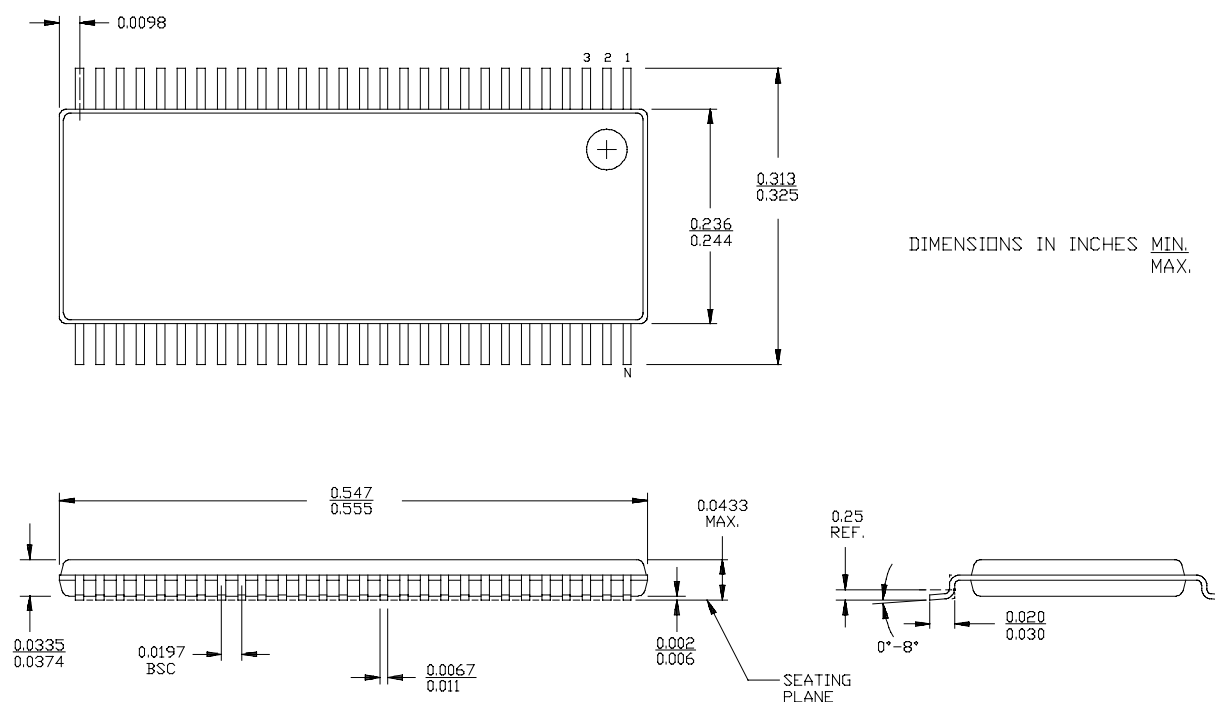
| Speed (ns) | Ordering Code      | Package Name | Package Type            | Operating Range |
|------------|--------------------|--------------|-------------------------|-----------------|
| 5.4        | 74FCT162652CTPACT  | Z56          | 56-Lead (240-Mil) TSSOP | Industrial      |
|            | CY74FCT162652CTPVC | O56          | 56-Lead (300-Mil) SSOP  |                 |
|            | 74FCT162652CTPVCT  | O56          | 56-Lead (300-Mil) SSOP  |                 |
| 6.3        | CY74FCT162652ATPVC | O56          | 56-Lead (300-Mil) SSOP  | Industrial      |
|            | 74FCT162652ATPVCT  | O56          | 56-Lead (300-Mil) SSOP  |                 |

**Package Diagrams**

**56-Lead Shrunk Small Outline Package O56**



**56-Lead Thin Shrunk Small Outline Package Z56**



**PACKAGING INFORMATION**

| Orderable Device   | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|--------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| 74FCT162652ATPVCG4 | ACTIVE                | SSOP         | DL              | 56   | 20          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74FCT162652ATPVCT  | ACTIVE                | SSOP         | DL              | 56   | 1000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74FCT162652CTPACT  | ACTIVE                | TSSOP        | DGG             | 56   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74FCT162652CTPVCG4 | ACTIVE                | SSOP         | DL              | 56   | 20          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74FCT162652CTPVCT  | ACTIVE                | SSOP         | DL              | 56   | 1000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74FCT162652ETPACT  | OBSOLETE              | TSSOP        | DGG             | 56   |             | TBD                     | Call TI          | Call TI                      |
| 74FCT162652ETPVCT  | OBSOLETE              | SSOP         | DL              | 56   |             | TBD                     | Call TI          | Call TI                      |
| 74FCT16652ATPVCG4  | ACTIVE                | SSOP         | DL              | 56   | 20          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74FCT16652ATPVCTG4 | ACTIVE                | SSOP         | DL              | 56   | 1000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74FCT16652CTPVCG4  | ACTIVE                | SSOP         | DL              | 56   | 20          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74FCT16652CTPVCTG4 | ACTIVE                | SSOP         | DL              | 56   | 1000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT162652ATPVC | ACTIVE                | SSOP         | DL              | 56   | 20          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT162652CTPVC | ACTIVE                | SSOP         | DL              | 56   | 20          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT162652ETPAC | OBSOLETE              | TSSOP        | DGG             | 56   |             | TBD                     | Call TI          | Call TI                      |
| CY74FCT162652ETPVC | OBSOLETE              | SSOP         | DL              | 56   |             | TBD                     | Call TI          | Call TI                      |
| CY74FCT16652ATPVC  | ACTIVE                | SSOP         | DL              | 56   | 20          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT16652ATPVCT | ACTIVE                | SSOP         | DL              | 56   | 1000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT16652CTPVC  | ACTIVE                | SSOP         | DL              | 56   | 20          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT16652CTPVCT | ACTIVE                | SSOP         | DL              | 56   | 1000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT16652ETPAC  | OBSOLETE              | TSSOP        | DGG             | 56   |             | TBD                     | Call TI          | Call TI                      |
| CY74FCT16652ETPACT | OBSOLETE              | TSSOP        | DGG             | 56   |             | TBD                     | Call TI          | Call TI                      |
| CY74FCT16652ETPVC  | OBSOLETE              | SSOP         | DL              | 56   |             | TBD                     | Call TI          | Call TI                      |
| CY74FCT16652ETPVCT | OBSOLETE              | SSOP         | DL              | 56   |             | TBD                     | Call TI          | Call TI                      |
| FCT162652ATPVCTG4  | ACTIVE                | SSOP         | DL              | 56   | 1000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| FCT162652CTPACTE4  | ACTIVE                | TSSOP        | DGG             | 56   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| FCT162652CTPACTG4  | ACTIVE                | TSSOP        | DGG             | 56   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| FCT162652CTPVCTG4  | ACTIVE                | SSOP         | DL              | 56   | 1000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

<sup>(1)</sup> The marketing status values are defined as follows:

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**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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**TAPE AND REEL INFORMATION**



\*All dimensions are nominal

| Device             | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| 74FCT162652ATPVCT  | SSOP         | DL              | 56   | 1000 | 330.0              | 32.4               | 11.35   | 18.67   | 3.1     | 16.0    | 32.0   | Q1            |
| 74FCT162652CTPACT  | TSSOP        | DGG             | 56   | 2000 | 330.0              | 24.4               | 8.6     | 15.6    | 1.8     | 12.0    | 24.0   | Q1            |
| 74FCT162652CTPVCT  | SSOP         | DL              | 56   | 1000 | 330.0              | 32.4               | 11.35   | 18.67   | 3.1     | 16.0    | 32.0   | Q1            |
| CY74FCT16652ATPVCT | SSOP         | DL              | 56   | 1000 | 330.0              | 32.4               | 11.35   | 18.67   | 3.1     | 16.0    | 32.0   | Q1            |
| CY74FCT16652CTPVCT | SSOP         | DL              | 56   | 1000 | 330.0              | 32.4               | 11.35   | 18.67   | 3.1     | 16.0    | 32.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device             | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| 74FCT162652ATPVCT  | SSOP         | DL              | 56   | 1000 | 346.0       | 346.0      | 49.0        |
| 74FCT162652CTPACT  | TSSOP        | DGG             | 56   | 2000 | 346.0       | 346.0      | 41.0        |
| 74FCT162652CTPVCT  | SSOP         | DL              | 56   | 1000 | 346.0       | 346.0      | 49.0        |
| CY74FCT16652ATPVCT | SSOP         | DL              | 56   | 1000 | 346.0       | 346.0      | 49.0        |
| CY74FCT16652CTPVCT | SSOP         | DL              | 56   | 1000 | 346.0       | 346.0      | 49.0        |

## DGG (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN

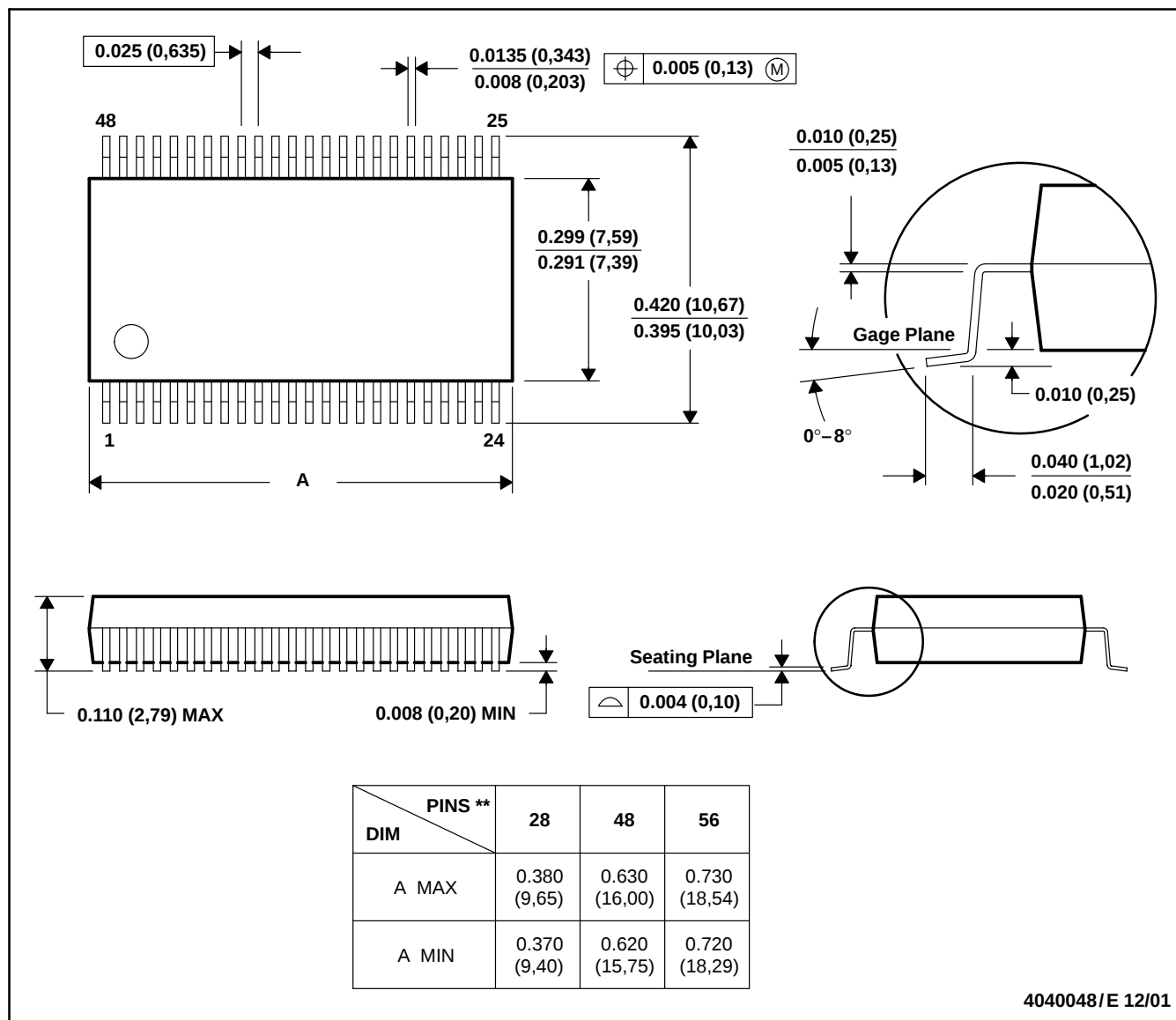


- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

DL (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).  
 D. Falls within JEDEC MO-118

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